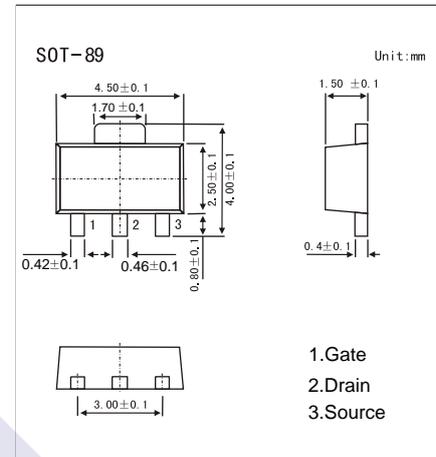
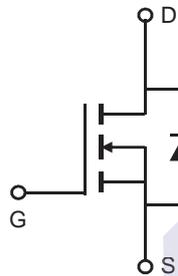


N-Channel MOSFET

2KK5034

■ Features

- $BV_{DSS} = 30\text{ V}$
- $I_D = 15\text{ A}$
- $R_{DS(ON)} < 9.2\text{ m}\Omega @ V_{GS} = 10\text{ V}$
- $R_{DS(ON)} < 10.8\text{ m}\Omega @ V_{GS} = 4.5\text{ V}$

■ Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Rating	Unit	
Drain-Source Voltage	V_{DS}	30	V	
Gate-Source Voltage	V_{GS}	± 20		
Continuous Drain Current (Note 1)	I_D	$T_A = 25^\circ\text{C}$	15	A
		$T_A = 100^\circ\text{C}$	12	
Pulsed Drain Current (Note 2)	I_{DM}	60		
Power Dissipation	P_D	3.5	W	
Thermal Resistance Junction-to-Ambient (Note 1)	$R_{\theta JA}$	35	$^\circ\text{C}/\text{W}$	
Junction Temperature	T_J	150	$^\circ\text{C}$	
Storage Temperature Range	T_{stg}	-55 to 150		

Notes:

1. Surface Mounted on 1in^2 FR4 Board, $t \leq 10\text{ sec.}$
2. Repetitive Rating: Pulse width limited by maximum junction temperature.

N-Channel MOSFET

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■ Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D = 250 \mu\text{A}$, $V_{GS} = 0\text{V}$	30			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 24\text{V}$, $V_{GS} = 0\text{V}$			1	μA
Gate to Source Leakage Current	I_{GSS}	$V_{DS} = 0\text{V}$, $V_{GS} = \pm 20\text{V}$			± 100	nA
On Characteristics (Note 3)						
Gate to Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250\mu\text{A}$	1.0		2.5	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = 10\text{V}$, $I_D = 30\text{A}$			9.2	m Ω
		$V_{GS} = 4.5\text{V}$, $I_D = 15\text{A}$			10.8	
Dynamic Characteristics (Note4)						
Input Capacitance	C_{iss}	$V_{GS} = 0\text{V}$, $V_{DS} = 15\text{V}$, $f = 1\text{MHz}$		1180		pF
Output Capacitance	C_{oss}			190		
Reverse Transfer Capacitance	C_{riss}			115		
Switching Characteristics (Note 4)						
Total Gate Charge	Q_g	$V_{GS} = 10\text{V}$, $V_{DS} = 15\text{V}$, $I_D = 30\text{A}$		20	24	nC
Gate Source Charge	Q_{gs}			2.2		
Gate Drain Charge	Q_{gd}			3.5		
Turn-On Delay Time	$t_{d(on)}$	$V_{GS} = 10\text{V}$, $V_{DS} = 15\text{V}$, $R_{GEN} = 6\ \Omega$, $R_L = 15\ \Omega$, $I_D = 1\text{A}$		11		ns
Turn-On Rise Time	t_r			12		
Turn-Off Delay Time	$t_{d(off)}$			36		
Turn-Off Fall Time	t_f			10		
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V_{SD}	$V_{GS} = 0\text{V}$, $I_S = 15\text{A}$			1.1	V

Notes:

- Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
- Guaranteed by design, not subject to production

■ Marking

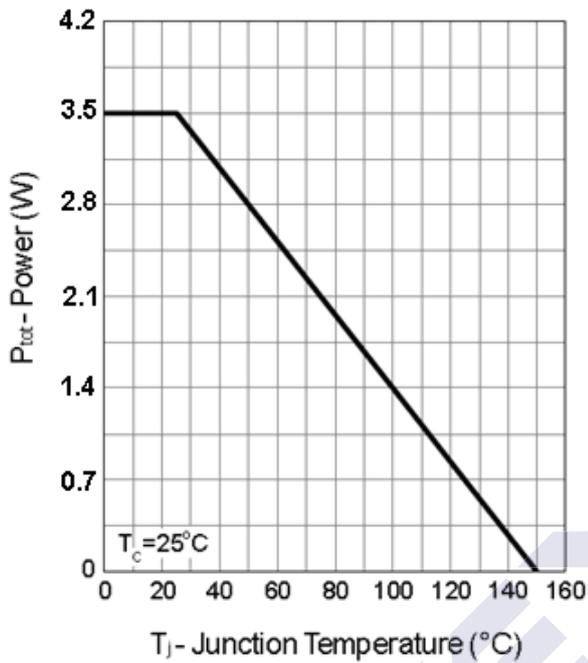
Marking	K5034
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N-Channel MOSFET

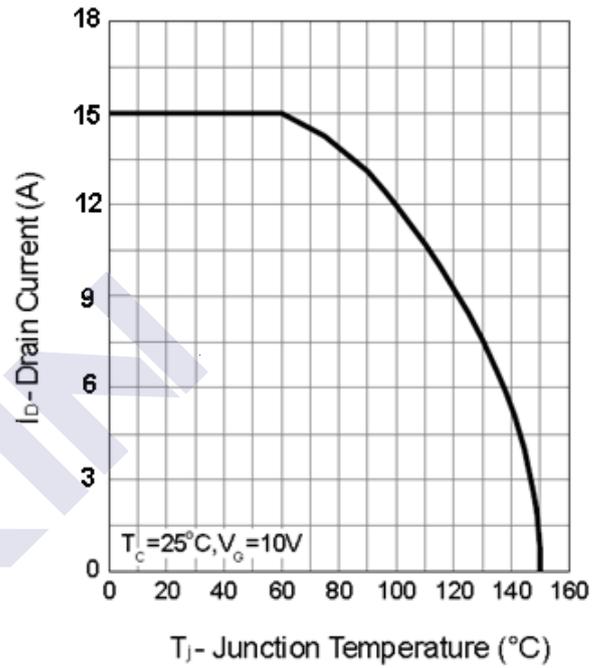
2KK5034

■ Typical Characteristics

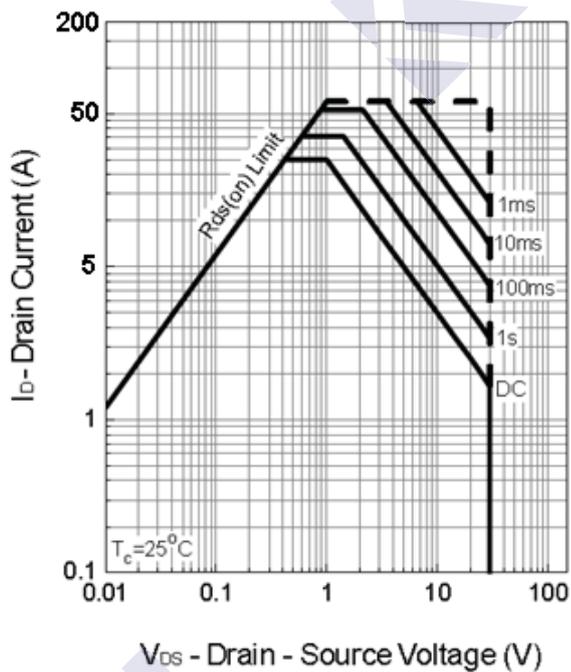
Power Dissipation



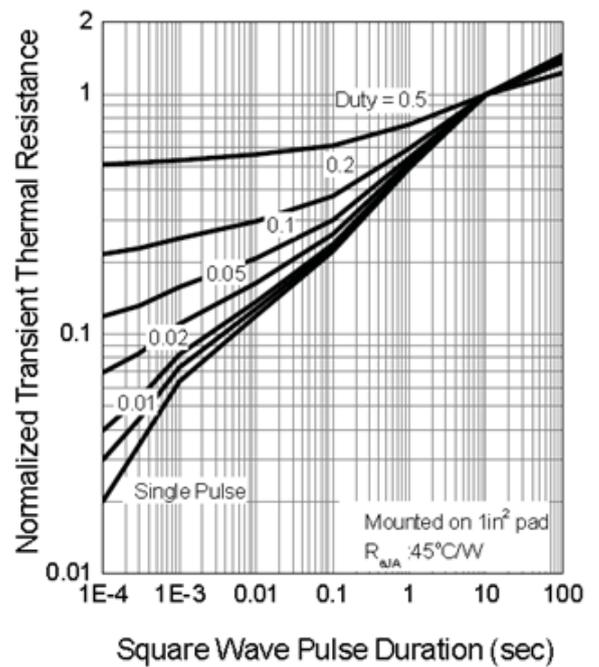
Drain Current



Safe Operation Area



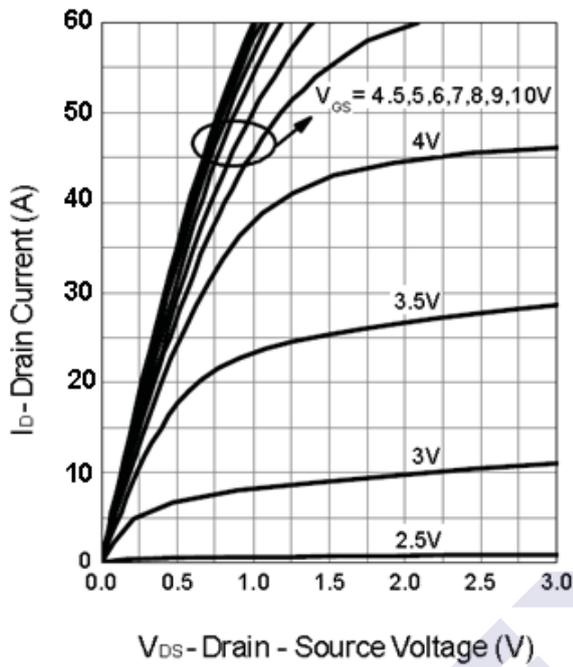
Thermal Transient Impedance



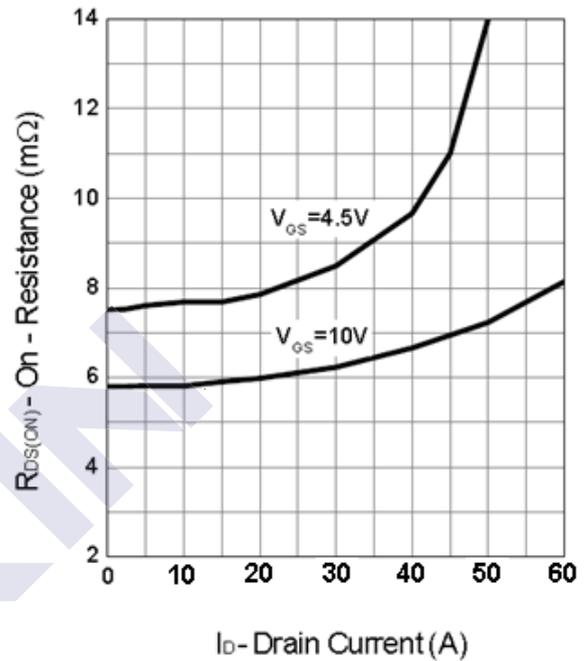
N-Channel MOSFET

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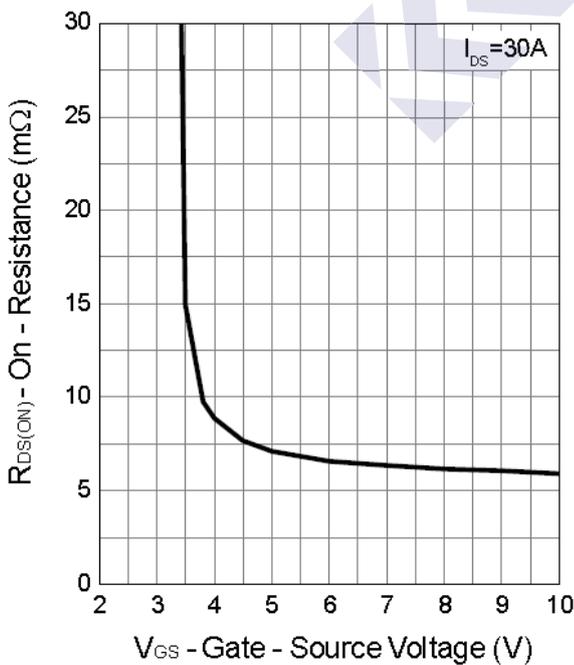
Output Characteristics



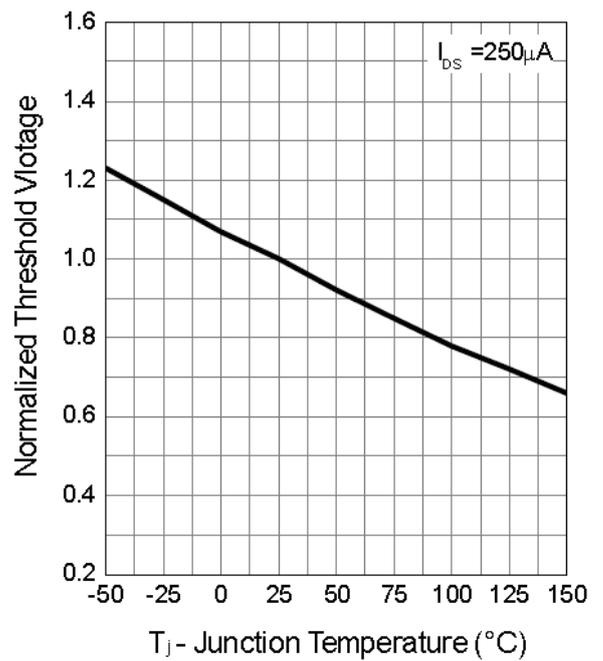
Drain-Source On Resistance



Gate-Source On Resistance



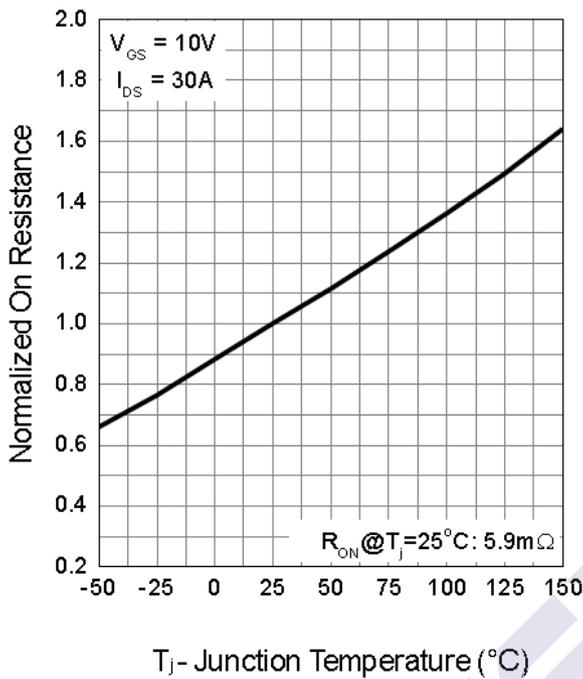
Gate Threshold Voltage



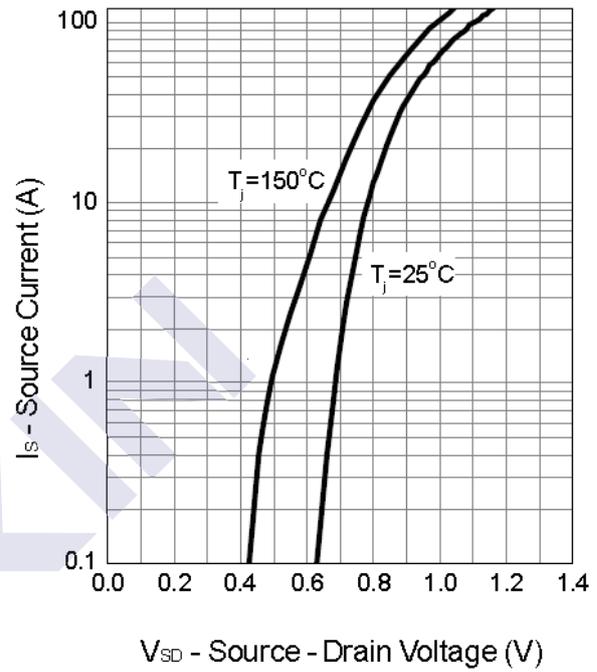
N-Channel MOSFET

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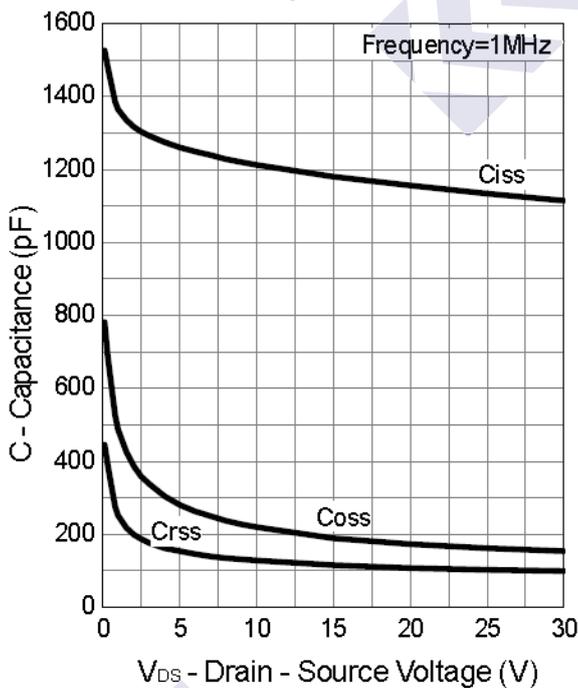
Drain-Source On Resistance



Source-Drain Diode Forward



Capacitance



Gate Charge

